



# Model : Uni-Holder Elliptical Fin

## BGA Heat Sink Specification

For 23x23 Chip set



1. Material : Al 6063
2. Dimension :  
Foot print : 23x23mm  
Height : 21 mm  
Base (thickness) : 2.6mm
3. Finish: Black Anodize
4. Accessory :  
Clip : Plastic (UL94-V0)
5. Clip available:  
Chip set thickness  
3.0-3.6mm **Y** - Yellow colored clip  
1.4-2.0mm **BU** - Blue colored clip  
0.5-1.1mm **O** - Orange colored clip



## Performance

|                   |       |
|-------------------|-------|
| Heat Source (LxW) | 23x23 |
|-------------------|-------|

